| PCI | N Number: | 20200430000 | | | | | PCN Date: | | | May | May 11, 2020 | |
|--|--|-------------|----------------------|--------------------|--------------|------|-----------|-------|-----------------|---------------------|-----------------------------|--|
| Titl | e: Datasheet fo | r TPS6 | 53030, | TPS | 563031 | | | | | | | |
| Customer Contact: PC | | | CN Manager | | | | | Dept: | | | Quality Services | |
| Proposed 1st Ship Date: Aug. | | | | | 11, 2020 | | | | | | | |
| Cha | inge Type: | | | | | | | | | | | |
| Assembly Site | | | Design | | | | | | Wafer Bump Site | | | |
| | Assembly Process | | | □ Data Sheet | | | | ĻĻ | | Wafer Bump Material | | |
| | Assembly Materials | | | Part number change | | | | ĻĻ | <u> </u> | Wafer Bump Process | | |
| Mechanical Specification | | | Test Site | | | | ᄔ | _ | | r Fab Site | | |
| | Packing/Shipping/Labeling | | | | Test Process | | | ┞╞ | 4 | | r Fab Materials | |
| | | | Natification Dataile | | | | L | | ware | r Fab Process | | |
| Notification Details | | | | | | | | | | | | |
| Description of Change: | | | | | | | | | | | | |
| Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. | | | | | | | | | | | | |
| | | | | | | | | | | | | |
| 4 | TEXAS | | | | | | | | | | TPS63030, TPS63031 | |
| , | Instruments | | | | | | S | LVS | 696 | D –OCTO | BER 2008-REVISED APRIL 2020 | |
| Changes from Revision C (August 2014) to Revision D | | | | | | | | | | | | |
| | Changed the max avera | age swite | ch curren | t limi | t to 1300 mA | | | | | | 5 | |
| | | _ | | | | | | | | | | |
| | Updated the Soft Start and Short Circuit Protection section 9 Corrected typos 10 | | | | | | | | | | | |
| | Added Table 4 | | | | | | | | | | 13 | |
| Corrected to TPS63030 | | | | | | | | 14 | | | | |
| • | Corrected to TPS63030 | | | | | | | | | | 14 | |
| _ | | | | | | | | | | | | |
| The | datasheet number | will b | e chan | ging | J . | | | | | | | |
| Device Family | | | | Change From: | | | | | | Chai | nge To: | |
| TPS63030, TPS63031 | | | SLVS696C | | | | | | SLVS | S696D | | |
| http://www.ti.com/product/TPS63030 | | | | | | | | | | | | |
| Rea | son for Change: | | | | | | | | | | | |
| To accurately reflect device characteristics. | | | | | | | | | | | | |
| Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative): | | | | | | | | | | | | |
| Electrical specification performance changes as indicated above. | | | | | | | | | | | | |
| Changes to product identification resulting from this PCN: | | | | | | | | | | | | |
| None. | | | | | | | | | | | | |
| Product Affected: | | | | | | | | | | | | |
| TP | S63030DSKR | TP | S6303 | 0DS | SKT | TPS6 | 3030DSk | Œ | 34 | 17 | ΓPS63031DSKR | |
| TP | S63031DSKT | TP | S6303 | 1DS | SKTG4 | | | | | | | |

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

| Location | E-Mail |
|---------------|--------------------------|
| DLP® PCN Team | dlp-pcn-team@list.ti.com |
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| Europe | PCNEuropeContact@list.ti.com | | | | | | |
|--------------|-------------------------------|--|--|--|--|--|--|
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